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| APPLICATION NO. | FILING DATE | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO. | CONFIRMATION NO. |
|-----------------------------------|-------------|----------------------|-------------------------|------------------|
| 10/767,439 | 01/30/2004 | Nobuhisa Kumamoto | AI 318D1 | 7225 |
| 7590 03/22/2006 | | EXAMINER | | |
| MR STEVEN | | CAO, PHAT X | | |
| C/O RABIN & BERDO PC SUITE 500 | | | ART UNIT | PAPER NUMBER |
| 1101 14TH STI | | 2814 | | |
| WASHINGTO | N, DC 20005 | | DATE MAILED: 03/22/2006 | |

Please find below and/or attached an Office communication concerning this application or proceeding.

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|--|---|--|----------|
| | Application No. | Applicant(s) | - |
| | 10/767,439 | KUMAMOTO ET AL. | |
| Office Action Summary | Examiner | Art Unit | ,, |
| · | Phat X. Cao | 2814 | |
| The MAILING DATE of this communication app Period for Reply | ears on the cover sheet with the c | orrespondence address | |
| A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). | ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE | N. nely filed the mailing date of this communic D (35 U.S.C. § 133). | |
| Status | | | |
| Responsive to communication(s) filed on 13 Dec 2a) ☐ This action is FINAL. 2b) ☐ This 3) ☐ Since this application is in condition for allowar closed in accordance with the practice under E | action is non-final. nce except for formal matters, pro | | ts is |
| Disposition of Claims | • | | |
| 4) ☐ Claim(s) 11-24 is/are pending in the application 4a) Of the above claim(s) 13-24 is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 11 and 12 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or | n from consideration. | | |
| Application Papers | | • | |
| 9) The specification is objected to by the Examine | r. | | |
| 10)☐ The drawing(s) filed on is/are: a)☐ acce | epted or b) objected to by the | Examiner. | |
| Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct | | • | 21(d). |
| 11)☐ The oath or declaration is objected to by the Ex | aminer. Note the attached Office | Action or form PTO-15 | 2. |
| Priority under 35 U.S.C. § 119 | | | |
| 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list | s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)). | on No. <u>09/504,874</u> . ed in this National Stage |) |
| Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date | 4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other: | | |



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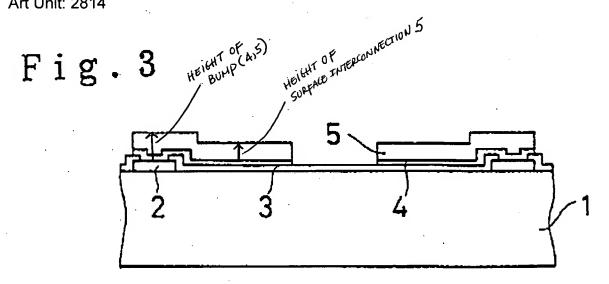
DETAILED ACTION

Claim Rejections - 35 USC § 102

- 1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:
 - A person shall be entitled to a patent unless -
 - (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 11-12 are rejected under 35 U.S.C. 102(b) as being anticipated by Mori (US. 5,604,379).

Regarding claim 11, Mori (Figs. 1-3) discloses a production process for a semiconductor chip, comprising the steps of: providing an internal interconnection 2 on a semiconductor substrate 1; forming a surface protective film 3 over the internal interconnection 2; forming an opening in the surface protective film 3 to expose a portion of the internal interconnection 2 (see Fig. 1); forming a bump (4,5) combining of two conductive layers 4 and 5 and projecting from the surface protective film 3 on the portion of the internal interconnection 2 exposed through the opening (see Fig. 3); and forming simultaneously with the formation of a part 5 of the bump (4,5), a surface interconnection 5 (see Fig. 3 below) electrically connected to the bump (4,5), the surface interconnection 5 having a smaller height than the bump (4,5) in a predetermined region on the surface protective film 3 except a portion thereof formed with the opening.

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Regarding claim 12, Mori (Figs. 1-3) further discloses that the bump (4,5) forming step includes the step of selectively depositing a conductive material 4 and 5 on the portion of the internal interconnection 2 exposed through the opening, and the surface interconnection 5 forming step includes the step of selectively depositing a conductive material 5 in the predetermined region on the surface protective film 3 except the portion thereof formed with the opening.

Response to Arguments

Applicant's arguments with respect to the claimed invention have been 3. considered but are most in view of the new ground(s) of rejection. Because of the new issues presented in the amended claims, the new reference is applied in the new ground of rejection.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in 4. this Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP

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§ 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Phat X. Cao whose telephone number is 571-272-1703. The examiner can normally be reached on M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 571-272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

PC

March 16, 2006

PHAT X. CAO
PRIMARY EXAMINER